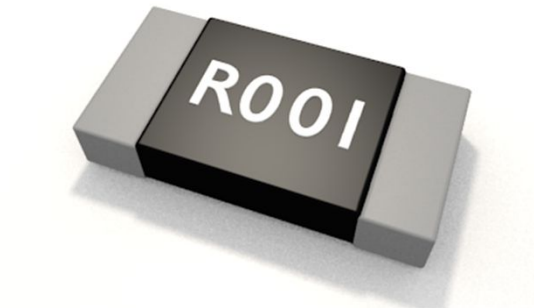


SLR series / Metal Strip _ Current Sensing Resistor



特徴 / Features

- 金属板構造。
 - 3264サイズで定格2W，3W
 - 大量生産が意図されたモデルで豊富な生産能力を実現。
 - 耐パルス性能に優れます。
 - 純粋な金属合金を抵抗体に採用。
 - 高精度で高安定な性能を実現
 - 様々な電流検出用途に最適です。
- Metal Strip Construction.
 - Rating 2W, 3W.on 3.2mm x 6.4mm.
 - High volume production suitable for commercial and special applications.
 - Excellent Pulse Endurance
 - Pure Metal Alloy
 - High precision tolerance and stabilities.
 - Suitable for useful in many Current Sensing Applications.

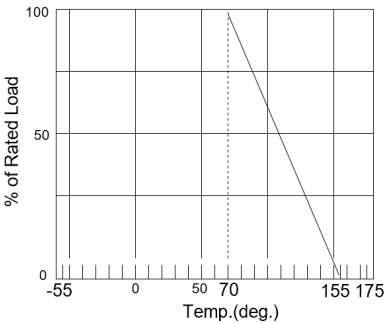
品番構成 / Ordering Code

S	L	R	6	4	3	2	H	M	R	0	0	1	F
品目記号 Product Code		形状 Size		定格電力 Power		特性 Type		抵抗値 Nominal Resistance		抵抗値許容差 R-Tolerance			
SLR 金属板 電流検出用抵抗器		6432		Blank: 2W H: 3W		M: Low TEMF		0.001Ω→R001 0.010Ω→R010		F= ± 1% D= ±0.5%			

定格 / Ratings

Type	SLR6432			SLR6432H		
サイズ Size in mm (inch)	6.4mm x 3.2mm (0.25inch x 0.12inch)					
定格電力 Power	2W			3W		
定格電圧 Rated Voltage Power	√(Power x Resistance)					
抵抗値許容差 Resistance Tolerance	± 1.0% (F), ±0.5% (D)					
標準抵抗値 Standard	0.5mΩ～0.75mΩ	1mΩ～1.5mΩ	2mΩ～50mΩ	0.5mΩ～0.75mΩ	1mΩ～1.5mΩ	2mΩ～50mΩ
抵抗温度係数 TCR, ppm/° C	± 150ppm/° C	± 100ppm/° C	± 50ppm/° C	± 150ppm/° C	± 100ppm/° C	± 50ppm/° C
使用温度範囲 Operating	-55° C ~ +155° C					
梱包数 Packaging	4,000pcs/reel			3,000pcs/reel		

負荷軽減曲線 / Derating Curve

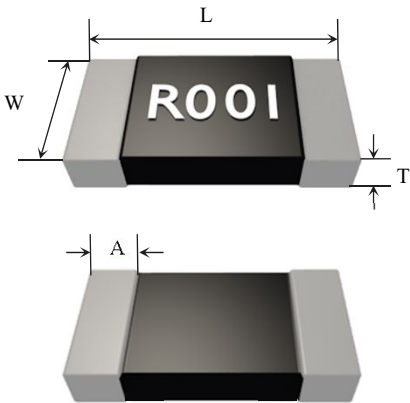


定格電力は、定格周囲温度以下において連続使用に適する負荷電力を指します。周囲温度が70℃を超える場合は、図の軽減曲線に従って定格電力を軽減して下さい。

Rated power is defined as load power suitable to continuous use only in Rated ambient temperature. You shall decrease rated power in accordance with above Power Derating curb-chart in case of ambient temperature of more than 70°C.

SLR series / Metal Strip _ Current Sensing Resistor

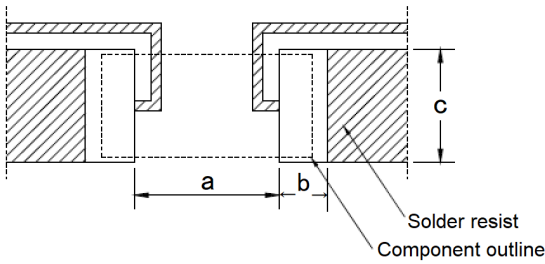
形状寸法 / Dimensions in mm



Dimensions in mm

型式 Series	SLR6432		SLR6432H	
	0.5mq ~ 1.5mq	2mq ~ 50mq	0.5mq ~ 0.75mq	1mq ~ 50mq
L	6.40 ± 0.30		6.40 ± 0.30	
W	3.20 ± 0.30		3.20 ± 0.30	
T	MAX 1.25		MAX 1.30	
A	1.90 ± 0.25	0.80 ± 0.25	1.90 ± 0.25	0.80 ± 0.25

推奨ランドパターン / Recommended Land Pattern for Current Sensing



Dimensions in mm

型式 Series	SLR6432		SLR6432H	
	0.5mq ~ 1.5mq	2mq ~ 50mq	0.5mq ~ 0.75mq	1mq ~ 50mq
a	1.50	3.18	3.18	3.18
b	2.95	2.11	2.95	2.11
c	3.57	3.57	3.57	3.57

性能 / Performance

試験方法 Parameter	試験条件 Conditions	判断基準 Requirements
短時間過負荷 Short Time Over Load	P= 5.0Pr ; T=25±2°C , t = 5sec	±(1.0%+0.5mΩ) IEC60115-1 4.13
高温放置 High Temp. Exposure	T = +170±2°C ; t = 1000h	±(1.0%+0.5mΩ) IEC60115-1 4.25
低温放置 Low Temp. Storage	T = -55±2°C ; t = 1000h	±(1.0%+0.5mΩ) IEC60115-1 4.25
耐湿負荷 Moisture Load Life (60°C、95%RH)	Vtest = Vmax ; T=60±2°C ; RH=95% ; t= 90min ON , 30min OFF , 1000h	±(2.0%+0.5mΩ) IEC60115-1 4.25
熱衝撃 Thermal Shock	[-55°C 30min. → R.T. 3min. → +155°C 30min → R.T. 3min],100Cycles	±(1.0%+0.5mΩ) IEC60115-1 4.19
高温負荷 Load Life at 70°C	Vtest = Vmax ; T=70±2°C ;t= 90min ON , 30min OFF,1000h	±(2.0%+0.5mΩ) IEC60115-1 4.25
半田濡れ性 Solderability	Dip into solder at T = 245±5°C , t = 3±0.5sec	The covered area >95% IEC60115-1 4.17
半田耐熱性 Resistance to Solder Heat	Through Reflow,3times T= 260±5°C , t =20±1sec	±(1.0%+0.5mΩ) IEC60115-1 4.18
機械的衝撃 Mechanical Shock	Acceleration a =100G , t =6ms	±(1.0%+0.5mΩ) IEC60115-1 4.21
基板曲げ Substrate Bending	Span between fulcrums : 90mm ; Bend Width : 2mm ; Test board/ Glass-Epoxy Board/ Thickness =1.6mm	±(1.0%+0.5mΩ) IEC60115-1 4.33